











SNAS650A - JANUARY 2015 - REVISED SEPTEMBER 2018

**TPL5110** 

# **TPL5110 Nano-Power System Timer for Power Gating**

#### 1 Features

- Supply Voltage From 1.8 V to 5.5 V
- Current Consumption at 2.5 V and 35 nA (Typical)
- Selectable Time Intervals: 100 ms to 7200 s
- Timer Accuracy: 1% (Typical)
- Resistor Selectable Time Interval
- Manual MOSFET Power On.
- · One-Shot Feature

### 2 Applications

- Battery-Powered Systems
- Internet of Things (IoT)
- Intruder Detection
- Tamper Detection
- Home Automation Sensors
- Thermostats
- Consumer Electronics
- Remote Sensor
- White Goods

### **B** Description

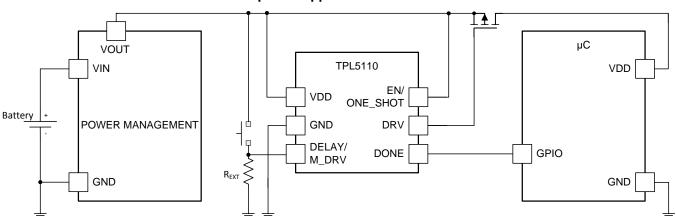
The TPL5110 Nano Timer is a low power timer with an integrated MOSFET driver designed for power gating in duty cycled or battery-powered applications. Consuming only 35 nA, the TPL5110 can enable the power supply line and drastically reduce the overall system stand by current during the sleep time. Such power savings enable the use of significantly smaller batteries for energy harvesting or wireless sensor applications. The TPL5110 provides selectable timing intervals from 100 ms to 7200 s and is designed for power gating applications. In addition, the TPL5110 has a unique One-shot feature where the timer will only power the MOSFET for one cycle. The TPL5110 is available in a 6-pin SOT23 package.

#### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TPL5110	SOT23 (6)	3.00 mm × 3.00 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

### **Simplified Application Schematic**



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.



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# 4 Revision History

CI	hanges from Original (January 2015) to Revision A	Page
•	Changed Description text	
•	Changed max IDD	!
•	Changed TPL5110 Timing labels	(
•	Changed Circuitry text	12
•	Changed T <sub>ADC</sub> and R <sub>D</sub> equations in the <i>Quantization Error</i> section	14
•	Added Receiving Notification of Documentation Updates section	19

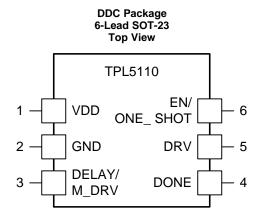
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# 5 Pin Configuration and Functions



**Pin Functions** 

	PIN	TYPE <sup>(1)</sup>	DESCRIPTION	APPLICATION INFORMATION
NO.	NAME	IYPE	DESCRIPTION	APPLICATION INFORMATION
1	VDD	Р	Supply voltage	
2	GND	G	Ground	
3	DELAY/ M_DRV	I	Time interval set and manual MOSFET Power ON	Resistance between this pin and GND is used to select the time interval. The manual MOSFET power ON switch is also connected to this pin.
4	DONE	I	Logic Input for watchdog functionality	Digital signal driven by the $\mu C$ to indicate successful processing.
5	DRV	0	Power Gating output signal generated every t <sub>IP</sub>	The Gate of the MOSFET is connected to this pin. When DRV = LOW, the MOSFET is ON.
6	EN/ ONE_SHOT	I	Selector of mode of operation	When EN/ONE_SHOT = HIGH, the TPL5110 works as a TIMER. When EN/ONE_SHOT = LOW, the TPL5110 turns on the MOSFET one time for the programmed time interval. The next power on of the MOSFET is enabled by the manual power ON.

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<sup>(1)</sup> G= Ground, P= Power, O= Output, I= Input.



### 6 Specifications

### 6.1 Absolute Maximum Ratings<sup>(1)</sup>

	MIN	MAX	UNIT
Supply Voltage (VDD-GND)	-0.3	6	V
Input Voltage at any pin <sup>(2)</sup>	-0.3	VDD + 0.3	V
Input Current on any pin	<b>-</b> 5	+5	mA
Junction Temperature, TJ <sup>(3)</sup>		150	°C
Storage Temperature, T <sub>stg</sub>	-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2) The voltage between any two pins should not exceed 6 V.

### 6.2 ESD Ratings

			VALUE	UNIT
		Human Body Model, per ANSI/ESDA/JEDEC JS-001 (1)	±1000	\ /
V <sub>(ESD)</sub>	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-101 <sup>(2)</sup>	±250	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Ratings

	MIN	MAX	UNIT
Supply Voltage (VDD-GND)	1.8	5.5	V
Temperature	-40	105	°C

#### 6.4 Thermal Information

	THERMAL METRIC <sup>(1)</sup>	DDC (SOT-23)	UNIT
		6 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	163	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	26	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	57	°C/W
ΨЈТ	Junction-to-top characterization parameter	7.5	°C/W
ΨЈВ	Junction-to-board characterization parameter	57	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	N/A	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report (SPRA953).

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<sup>(3)</sup> The maximum power dissipation is a function of T<sub>J</sub>(MAX), θJA, and the ambient temperature, T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is PDMAX = (T<sub>J</sub>(MAX) - T<sub>A</sub>)/ θJA. All numbers apply for packages soldered directly onto a printed-circuit board (PCB).



### 6.5 Electrical Characteristics(1)

Specifications are for  $T_A$ = 25°C, VDD-GND = 2.5 V, unless otherwise stated.

	PARAMETER	TEST CO	NDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
POWER SU	PPLY						
IDD	Supply current <sup>(4)</sup>	Operation mode			35	50	nA
		Digital conversion or resistance (Rext)	f external		200	400	μΑ
TIMER							
t <sub>IP</sub>	Time interval Period	1650 selectable Minimum time Interval interval			100		ms
			Maximum time interval		7200		s
	Time interval Setting Accuracy <sup>(5)</sup>	Excluding the precis	sion of Rext		±0.6%		
	Time interval Setting Accuracy over supply voltage	1.8 V ≤ VDD ≤ 5.5 V	V		±25		ppm/V
tosc	Oscillator Accuracy			-0.5%		0.5%	
	Oscillator Accuracy over temperature <sup>(6)</sup>	-40°C ≤ T <sub>A</sub> ≤ 105°C			±100	±400	ppm/°C
	Oscillator Accuracy over supply voltage	1.8 V ≤ VDD ≤ 5.5 V	V		±0.4		%/V
	Oscillator Accuracy over life time (7)				±0.24%		
t <sub>DONE</sub>	DONE Pulse width (6)			100			ns
t <sub>DRV</sub>	DRV Pulse width	DONE signal not re	ceived		t <sub>IP</sub> -50 ms		
t_Rext	Time to convert Rext				100	120	ms
DIGITAL LC	GIC LEVELS						
VIH	Logic High Threshold DONE pin			0.7 × VDD			V
VIL	Logic Low Threshold DONE pin					0.3 × VDD	V
VOH	Laria autaut High Laval DDV gia	lout = 100 μA		VDD - 0.3			V
VOH	Logic output High Level DRV pin	lout = 1 mA		VDD - 0.7			V
VOL	Logic output Low Lovel DBV six	lout = -100 μA				0.3	V
VOL	Logic output Low Level DRV pin	lout = -1 mA				0.7	V
$VIH_{M\_DRV}$	Logic High Threshold DELAY/M_DRV pin			1.5			V

- (1) Electrical Characteristics values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ . Absolute Maximum Ratings indicate junction temperature limits beyond which the device may be permanently degraded, either mechanically or electrically.
- (2) Limits are specified by testing, design, or statistical analysis at 25°C. Limits over the operating temperature range are specified through correlations using statistical quality control (SQC) method.
- Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not specified on shipped production material.
- The supply current excludes load and pullup resistor current. Input pins are at GND or VDD.
- The accuracy for time interval settings below 1 second is ±100 ms.
- This parameter is specified by design and/or characterization and is not tested in production.
- Operational life time test procedure equivalent to 10 years.

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### 6.6 Timing Requirements

			MIN <sup>(1)</sup> NOM <sup>(2)</sup> MAX <sup>(</sup>	UNIT
tr <sub>DRV</sub>	Rise Time DRV <sup>(3)</sup>	Capacitive load 50 pF	50	ns
tf <sub>DRV</sub>	Fall Time DRV <sup>(3)</sup>	Capacitive load 50 pF	50	ns
	DOME : DDV I I	Minimum delay (4)	100	ns
tD <sub>DONE</sub>	DONE to DRV delay	Maximum delay (4)	t <sub>DRV</sub>	
t <sub>M_DRV</sub>	Valid manual MOSFET Power ON	Observation time 30 ms	20	ms
t <sub>DB</sub>	De-bounce manual MOSFET Power ON		20	ms

- (1) Limits are specified by testing, design, or statistical analysis at 25°C. Limits over the operating temperature range are specified through correlations using statistical quality control (SQC) method.
- Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not specified on shipped production material.

  This parameter is specified by design and/or characterization and is not tested in production.
- From DRV falling edge.

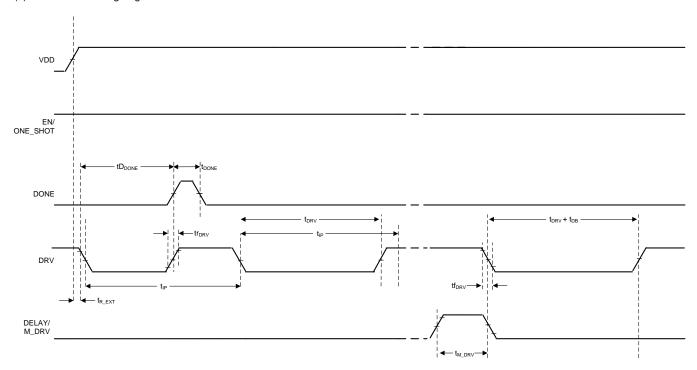


Figure 1. TPL5110 Timing

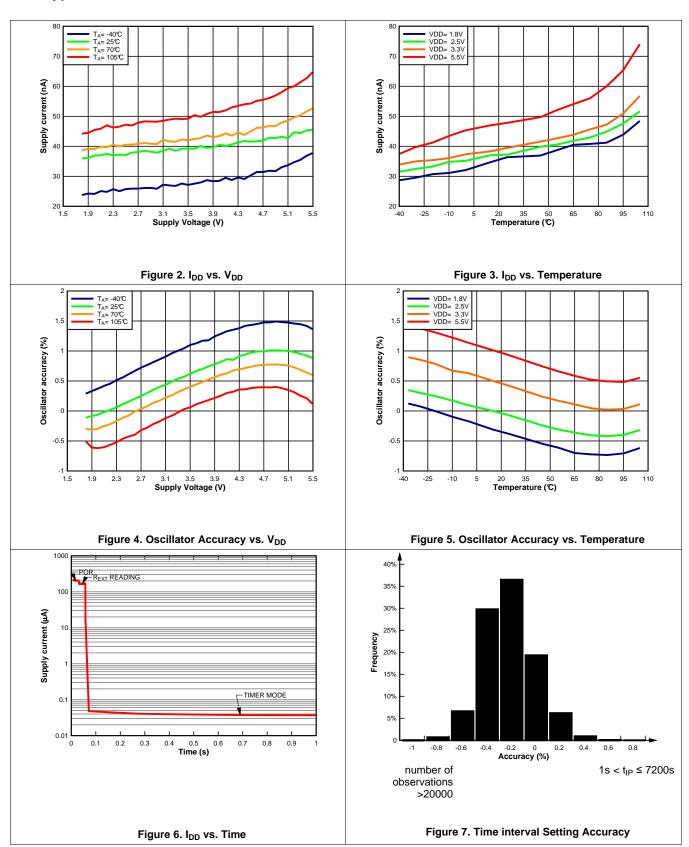
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### 6.7 Typical Characteristics



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### 7 Detailed Description

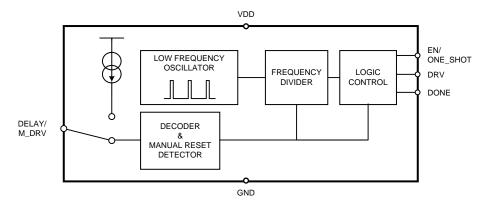
#### 7.1 Overview

The TPL5110 is a timer with power gating feature. It is ideal for use in power-cycled applications and provides selectable timing from 100 ms to 7200 s.

Once configured in timer mode (EN/ONE\_SHOT= HIGH) the TPL5110 periodically sends out a DRV signal to a MOSFET to turn on the  $\mu$ C. If the  $\mu$ C replies with a DONE signal within the programmed time interval ( $t_{DRV}$ ) the TPL5110 turns off the  $\mu$ C, otherwise the TPL5110 keeps the  $\mu$ C in the on state for a time equal to  $t_{DRV}$ .

The TPL5110 can work also in a one-shot mode (EN/ONE\_SHOT= LOW). In this mode the DRV signal is sent out just one time at the power on of the TPL5110 to turn on the  $\mu$ C. If the  $\mu$ C replies with a DONE signal within the programmed time interval ( $t_{DRV}$ ) the TPL5110 turns off the  $\mu$ C, otherwise the TPL5110 keeps the  $\mu$ C in the on state for a time equal to  $t_{DRV}$ .

#### 7.2 Functional Block Diagram



#### 7.3 Feature Description

The TPL5110 implements a periodical power gating feature or one shot power gating according to the EN/ONE\_SHOT voltage. A manual MOSFET Power ON function is realized by momentarily pulling the DELAY/M DRV pin to VDD.

#### 7.3.1 DRV

The gate of the MOSFET is connected to the DRV pin. When DRV=LOW, the MOSFET is turned ON. The pulse generated at DRV is equal to the selected time interval period, minus 50 ms. It is shorter in the case of a DONE signal received from the  $\mu$ C. If the DONE signal is not received within the programmed time interval (minus 50 ms), the DRV signal will be high for the last 50 ms of the time interval to turn off the MOSFET before the next cycle starts.

The default value (after resistance reading) is HIGH. The signal is sent out from the TPL5110 when the programmed time interval starts. When the DRV is LOW, the manual power ON signal is ignored.

#### 7.3.2 **DONE**

The DONE pin is driven by a  $\mu$ C to signal that the  $\mu$ C is working properly. The TPL5110 recognizes a valid DONE signal as a low to high transition. If two or more DONE signals are received within the time interval, only the first DONE signal is processed. The minimum DONE signal pulse length is 100 ns. When the TPL5110 receives the DONE signal it asserts DRV logic HIGH.

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#### 7.4 Device Functional Modes

### 7.4.1 Start-Up

During start-up, after POR, the TPL5110 executes a one-time measurement of the resistance attached to the DELAY/M\_DRV pin in order to determine the desired time interval for DRV. This measurement interval is  $t_{R\_EXT}$ . During this measurement a constant current is temporarily flowing into  $R_{EXT}$ .

Once the reading of the external resistance is complete, the TPL5110 enters automatically in one of the two modes according to the EN/ONE\_SHOT value. The EN/ONE\_SHOT pin needs to be hard wired to GND or VDD according to the required mode of operation.

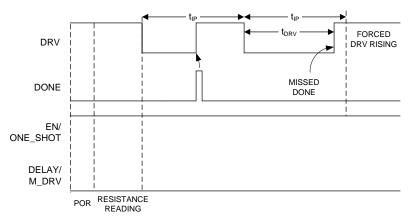


Figure 8. Start-Up - Timer Mode

#### 7.4.2 Timer Mode

During timer mode (EN/ONE\_SHOT = HIGH), the TPL5110 asserts periodic DRV pulses according to the programmed time interval. The length of the DRV pulses is set by the receiving of a DONE pulse from the  $\mu$ C. See Figure 8.

#### 7.4.3 One-Shot Mode

During one-shot mode (EN/ONE\_SHOT = LOW), the TPL5110 generates just one pulse at the DRV pin which lasts according to the programmed time interval. In one-shot mode, other DRV pulses can be triggered using the DELAY/M\_DRV pin. If a valid manual power ON occurs when EN/ONE\_SHOT is LOW, the TPL5110 generates just one pulse at the DRV pin. The duration of the pulse is set by the programmed time interval. Also in this case, if a DONE signal is received within the programmed time interval (minus 50 ms), the MOSFET connected to the DRV pin is turned off. See Figure 9 and Figure 10.

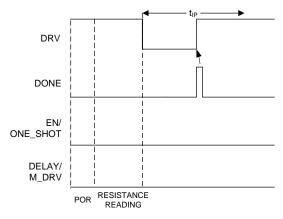


Figure 9. Start-Up One-Shot Mode (DONE Received Within t<sub>IP</sub>)

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### **Device Functional Modes (continued)**

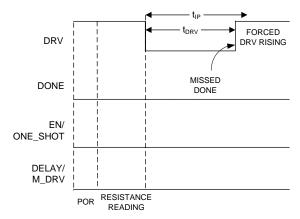


Figure 10. Start-Up One-Shot Mode (No DONE Received Within t<sub>IP</sub>)

### 7.5 Programming

### 7.5.1 Configuring the Time Interval With the DELAY/M\_DRV Pin

The time interval between two adjacent DRV pulses (falling edges, in timer mode) is selectable through an external resistance ( $R_{EXT}$ ) between the DELAY/M\_DRV pin and ground. The resistance ( $R_{EXT}$ ) must be in the range between 500  $\Omega$  and 170 k $\Omega$ . At least a 1% precision resistance is recommended. See section *Selection of the External Resistance* on how to set the time interval using  $R_{EXT}$ .

### 7.5.2 Manual MOSFET Power ON Applied to the DELAY/M\_DRV Pin

If VDD is connected to the DELAY/M\_DRV pin, the TPL5110 recognizes this as a manual MOSFET Power ON condition. In this case the time interval is not set. If the manual MOSFET Power ON is asserted during the POR or during the reading procedure, the reading procedure is aborted and is restarted as soon as the manual MOSFET Power ON switch is released. A pulse on the DELAY/M\_DRV pin is recognized as a valid manual MOSFET Power ON only if it lasts at least 20 ms (observation time is 30 ms). The manual MOSFET Power ON may be implemented using a switch (momentary mechanical action).

If the DRV is already LOW (MOSFET ON) the manual MOSFET Power ON is ignored.

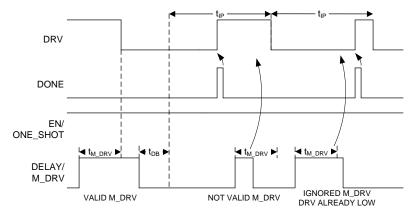


Figure 11. Manual MOSFET Power ON in Timer Mode

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### Programming (continued)

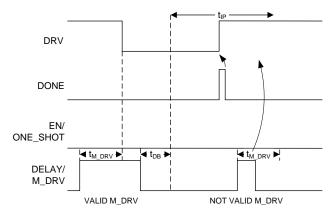


Figure 12. Manual MOSFET Power ON in One-Shot Mode

#### 7.5.2.1 **DELAY/M DRV**

A resistance in the range between 500  $\Omega$  and 170 k $\Omega$  must to be connected to the DELAY/M DRV pin to select a valid time interval. At the POR and during the reading of the resistance, the DELAY/M\_DRV is connected to an analog signal chain through a mux. After the reading of the resistance, the analog circuit is switched off and the DELAY/M DRV is connected to a digital circuit.

In this state, a logic HIGH applied to the DELAY/M\_DRV pin is interpreted by the TPL5110 as a manual power ON. The manual power ON detection is provided with a de-bounce feature (on both edges) which makes the TPL5110 insensitive to the glitches on the DELAY/M DRV.

The M DRV must stay high for at least 20 ms to be valid. Once a valid signal at DELAY/M DRV is understood as a manual power on, the DRV signal will be asserted in the next 10 ms. Its duration will be according to the programmed time interval (minus 50 ms), or less if the DONE is received.

A manual power ON signal resets all the counters. The counters will restart as soon as a valid manual power ON signal is recognized and the signal at DELAY/M DRV pin is asserted LOW. Due to the asynchronous nature of the manual power ON signal and its arbitrary duration, the LOW status of the DRV signal may be affected by an uncertainty of about ±5 ms.

An extended assertion of a logic HIGH at the DELAY/M\_DRV pin will turn on the MOSFET for a time longer than the programmed time interval. DONE signals received while the DELAY/M\_DRV is HIGH are ignored. If the DRV is already LOW (MOSFET ON) the manual power ON is ignored.

#### 7.5.2.2 Circuitry

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The manual Power ON may be implemented using a switch (momentary mechanical action). The TPL5110 offers two possible approaches according to the power consumption constraints of the application.



### **Programming (continued)**

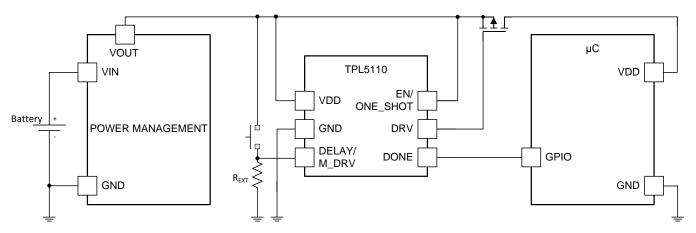


Figure 13. Manual MOSFET Power ON With SPST Switch

For use cases that do not require the lowest power consumption, using a single-pole single-throw switch may offer a lower-cost solution. The DELAY/M\_DRV pin may be directly connected to VDD with  $R_{\text{EXT}}$  in the circuit. The current drawn from the supply voltage during the manual power ON is given by VDD/ $R_{\text{EXT}}$ .

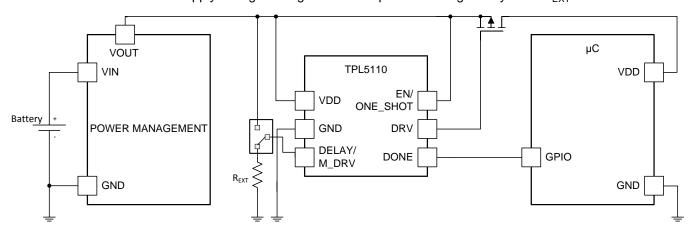


Figure 14. Manual MOSFET Power ON With SPDT Switch

The manual MOSFET Power ON function may also be asserted by switching DELAY/M\_DRV from R<sub>EXT</sub> to VDD using a single-pole double-throw switch, which will provide a lower power solution for the manual power ON, because no current flows.

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#### 7.5.3 Selection of the External Resistance

To set the time interval, the external resistance R<sub>EXT</sub> is selected according to Equation 1:

$$R_{EXT} = 100 \left( \frac{-b + \sqrt{b^2 - 4a(c - 100 T)}}{2a} \right)$$

where

- T is the desired time interval in seconds.
- $R_{EXT}$  is the resistance value to use in  $\Omega$ .
- a, b, c are coefficients depending on the range of the time interval.

(1)

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### **Programming (continued)**

Table 1. Coefficients for Equation 1

SET	Time Interval Range (s)	a	b	С
1	1 <t≤ 5<="" td=""><td>0.2253</td><td>-20.7654</td><td>570.5679</td></t≤>	0.2253	-20.7654	570.5679
2	5 <t≤ 10<="" td=""><td>-0.1284</td><td>46.9861</td><td>-2651.8889</td></t≤>	-0.1284	46.9861	-2651.8889
3	10 <t≤ 100<="" td=""><td>0.1972</td><td>-19.3450</td><td>692.1201</td></t≤>	0.1972	-19.3450	692.1201
4	100 <t≤ 1000<="" td=""><td>0.2617</td><td>-56.2407</td><td>5957.7934</td></t≤>	0.2617	-56.2407	5957.7934
5	T> 1000	0.3177	-136.2571	34522.4680

#### **EXAMPLE**

Required time interval: 8 s

The coefficient set to be selected is the number 2. The formula becomes Equation 2.

$$R_{EXT} = 100 \left( \frac{46.9861 - \sqrt{46.9861^2 + 4*0.1284(-2561.8889 - 100*8)}}{2*0.1284} \right)$$
 (2)

The resistance value is 10.18 k $\Omega$ .

Table 2 and Table 3 contain example values of t<sub>IP</sub> and their corresponding value of R<sub>EXT</sub>.

**Table 2. First 9 Time Intervals** 

t <sub>IP</sub> (ms)	Resistance (Ω)	Closest real value (Ω)	Parallel of two 1% tolerance resistors, $(k\Omega)$
100	500	500	1.0 // 1.0
200	1000	1000	-
300	1500	1500	2.43 // 3.92
400	2000	2000	-
500	2500	2500	4.42 // 5.76
600	3000	3000	5.36 // 6.81
700	3500	3500	4.75 // 13.5
800	4000	4000	6.19 // 11.3
900	4500	4501	6.19 // 16.5

Table 3. Most Common Time Intervals Between 1s to 2h

t <sub>IP</sub>	Calculated Resistance (kΩ)	Closest Real Value (kΩ)	Parallel of Two 1% Tolerance Resistors,( $k\Omega$ )				
1s	5.20	5.202	7.15 // 19.1				
2s	6.79	6.788	12.4 // 15.0				
3s	7.64	7.628	12.7// 19.1				
4s	8.30	8.306	14.7 // 19.1				
5s	8.85	8.852	16.5 // 19.1				
6s	9.27	9.223	18.2 // 18.7				
7s	9.71	9.673	19.1 // 19.6				
8s	10.18	10.180	11.5 // 8.87				
9s	10.68	10.68	17.8 // 26.7				
10s	11.20	11.199	15.0 // 44.2				
20s	14.41	14.405	16.9 // 97.6				
30s	16.78	16.778	32.4 // 34.8				
40s	18.75	18.748	22.6 // 110.0				
50s	20.047	20.047	28.7 // 66.5				

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Table 3. Most Common Time Intervals Between 1s to 2h (continued)

t <sub>IP</sub>	Calculated Resistance (k $\Omega$ )	Closest Real Value (kΩ)	Parallel of Two 1% Tolerance Resistors,(k $\Omega$ )		
1min	22.02	22.021	40.2 // 48.7		
2min	29.35	29.349	35.7 // 165.0		
3min	34.73	34.729	63.4 // 76.8		
4min	39.11	39.097	63.4 // 102.0		
5min	42.90	42.887	54.9 // 196.0		
6min	46.29	46.301	75.0 // 121.0		
7min	49.38	49.392	97.6 // 100.0		
8min	52.24	52.224	88.7 // 127.0		
9min	54.92	54.902	86.6 // 150.0		
10min	57.44	57.437	107.0 // 124.0		
20min	77.57	77.579	140.0 // 174.0		
30min	92.43	92.233	182.0 // 187.0		
40min	104.67	104.625	130.0 // 536.00		
50min	115.33	115.331	150.0 // 499.00		
1h	124.91	124.856	221.0 // 287.00		
1h30min	149.39	149.398	165.0 // 1580.0		
2h	170.00	170.00	340.0 // 340.0		

#### 7.5.4 Quantization Error

The TPL5110 can generate 1650 discrete timer intervals in the range of 100 ms to 7200 s. The first 9 intervals are multiples of 100 ms. The remaining 1641 intervals cover the range between 1 s to 7200 s. Because they are discrete intervals, there is a quantization error associated with each value.

The quantization error can be evaluated according to Equation 3:

$$Err = 100 \frac{\left(T_{DESIRED} - T_{ADC}\right)}{T_{DESIRED}}$$

where

$$T_{ADC} = INT \left[ \frac{1}{100} \left( aR_D^2 + bR_D + c \right) \right]$$

$$R_D = \frac{R_{EXT}}{100}$$
(3)

 $R_{\text{EXT}}$  is the resistance calculated with Equation 1 and a, b, c are the coefficients of the equation listed in Table 1.

#### 7.5.5 Error Due to Real External Resistance

 $R_{\text{EXT}}$  is a theoretical value and may not be available in standard commercial resistor values. It is possible to closely approach the theoretical  $R_{\text{EXT}}$  using two or more standard values in parallel. However, standard values are characterized by a certain tolerance. This tolerance will affect the accuracy of the time interval.

The accuracy can be evaluated using the following procedure:

- 1. Evaluate the min and max values of R<sub>EXT</sub> (R<sub>EXT\_MIN</sub>, R<sub>EXT\_MAX</sub> with Equation 1 using the selected commercial resistance values and their tolerances.
- 2. Evaluate the time intervals  $(T_{ADC\_MIN}[R_{EXT\_MIN}], T_{ADC\_MAX}[R_{EXT\_MAX}])$  with the  $T_{ADC}$  equation mentioned in Equation 3.

Product Folder Links: TPL5110

3. Find the errors using Equation 3 with  $T_{ADC\_MIN}$ ,  $T_{ADC\_MAX}$ .

The results of the formula indicate the accuracy of the time interval.

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The example below illustrates the procedure.

- Desired time interval, T\_desired = 600 s,
- Required R<sub>EXT</sub> from Equation 1, R<sub>EXT</sub>= 57.44 kΩ.

From Table 3,  $R_{EXT}$  can be built with a parallel combination of two commercial values with 1% tolerance: R1 =1 07 k $\Omega$ , R2 = 124 k $\Omega$ . The uncertainty of the equivalent parallel resistance can be found using Equation 4:

$$uR_{H} = R_{H} \sqrt{\left(\frac{u_{R1}}{R1}\right)^{2} + \left(\frac{u_{R2}}{R2}\right)^{2}}$$

where

• uRn (n=1,2) represent the uncertainty of a resistance (see Equation 5) (4)

$$u_{R_n} = Rn \frac{Tolerance}{\sqrt{3}} \tag{5}$$

The uncertainty of the parallel resistance is 0.82%, which means the value of  $R_{EXT}$  may range between  $R_{EXT\_MIN}$  = 56.96 k $\Omega$  and  $R_{EXT\_MAX}$  = 57.90 k $\Omega$ .

Using these value of  $R_{EXT}$ , the digitized timer intervals calculated by  $T_{ADC}$  equation mentioned in Equation 3 are respectively  $T_{ADC\_MIN} = 586.85$  s and  $T_{ADC\_MAX} = 611.3$  s, giving an error range of -1.88% / +2.19%. The asymmetry of the error range is due to the quadratic transfer function of the resistance digitizer.

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### 8 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

In battery-powered applications, one design constraint is the need for low current consumption. The TPL5110 is designed for applications where there is a need to monitor environmental conditions at a fixed time interval. Often in these applications a watchdog or other internal timer in a  $\mu$ C is used to implement a wake-up function. Typically, the power consumption of these functions is not optimized. Using the TPL5110 to implement a periodical power gating of the  $\mu$ C or of the entire system the current consumption will be only tens of nA.

### 8.2 Typical Application

The TPL5110 can be used in environment sensor nodes such as humidity and temperature sensor node. The sensor node has to measure the humidity and the temperature and transmit the data through a low power RF micro such as the CC2531. The temperature and the humidity in home application do not change so fast, so the measurement and the transmission of the data can be done at very low rate, such as every 30 seconds. The RF micro should spend most of the time in counting the elapsed time, but using the TPL5110 it is possible to complete turn off the RF micro and extend the battery life. The TPL5110 will turn on the RF micro when the programmed time interval elapses or for debug purpose with the manual MOSFET Power ON switch.

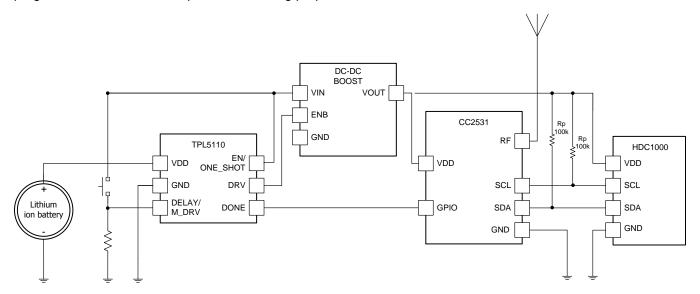


Figure 15. Sensor Node

#### 8.2.1 Design Requirements

The design is driven by the low current consumption constraint. The data are usually acquired on a rate which is in the range between 30 s and 60 s. The highest necessity is the maximization of the battery life. The TPL5110 helps achieve this goal because it allows turning off the RF micro.

#### 8.2.2 Detailed Design Procedure

When the focal constraint is the battery life, the selection of a low power voltage regulator and low leakage MOSFET to power gate the  $\mu C$  is mandatory. The first step in the design is the calculation of the power consumption of each device in the different mode of operations. An example is the HDC1000, in measurement mode the RF micro is in normal operation and transmission. The different modes offer the possibility to select the appropriate time interval which respect the application constraint and maximize the life of the battery.

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### **Typical Application (continued)**

#### 8.2.3 Application Curve

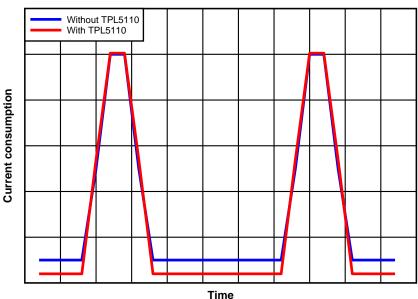


Figure 16. Effect of TPL5110 on Current Consumption

### 9 Power Supply Recommendations

The TPL5110 requires a voltage supply within 1.8 V and 5.5 V. A multilayer ceramic bypass X7R capacitor of 0.1  $\mu$ F between VDD and GND pin is recommended.

# 10 Layout

### 10.1 Layout Guidelines

The DELAY/M\_DRV pin is sensitive to parasitic capacitance. TI suggests that the traces connecting the resistance on this pin to GROUND be kept as short as possible to minimize parasitic capacitance. This capacitance can affect the initial set up of the time interval. Signal integrity on the DRV pin is also improved by keeping the trace length between the TPL5110 and the gate of the MOSFET short to reduce the parasitic capacitance. The EN/ONE\_SHOT needs to be tied to GND or VDD with short traces.



### 10.2 Layout Example

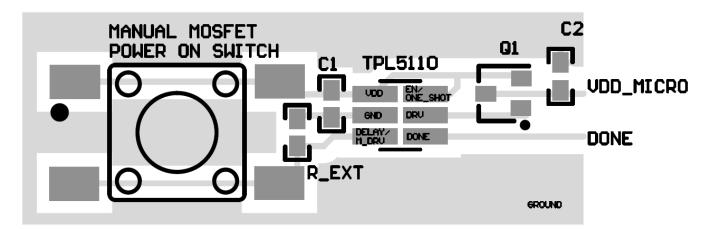


Figure 17. Layout



### 11 Device and Documentation Support

#### 11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 11.3 Trademarks

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#### 11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

### PACKAGE OPTION ADDENDUM



10-Dec-2020

#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TPL5110DDCR	ACTIVE	SOT-23-THIN	DDC	6	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	ZALX	Samples
TPL5110DDCT	ACTIVE	SOT-23-THIN	DDC	6	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	ZALX	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## **PACKAGE OPTION ADDENDUM**



10-Dec-2020

#### OTHER QUALIFIED VERSIONS OF TPL5110:

• Automotive: TPL5110-Q1

NOTE: Qualified Version Definitions:

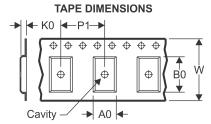
• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

# PACKAGE MATERIALS INFORMATION

www.ti.com 3-Mar-2017

### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



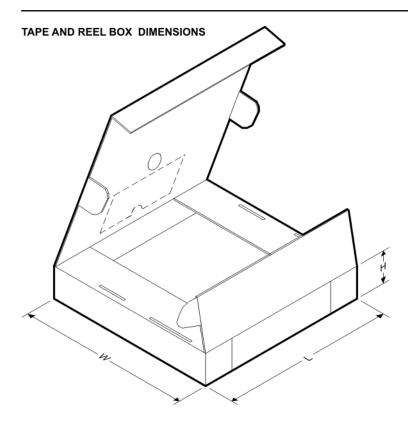
#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPL5110DDCR	SOT- 23-THIN	DDC	6	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPL5110DDCT	SOT- 23-THIN	DDC	6	250	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3



# PACKAGE MATERIALS INFORMATION

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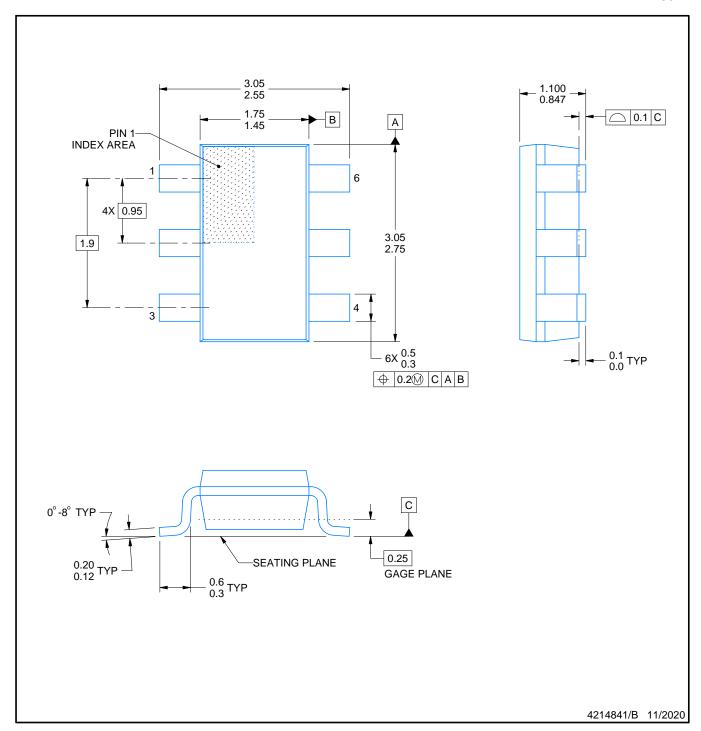


#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPL5110DDCR	SOT-23-THIN	DDC	6	3000	210.0	185.0	35.0
TPL5110DDCT	SOT-23-THIN	DDC	6	250	210.0	185.0	35.0



SOT

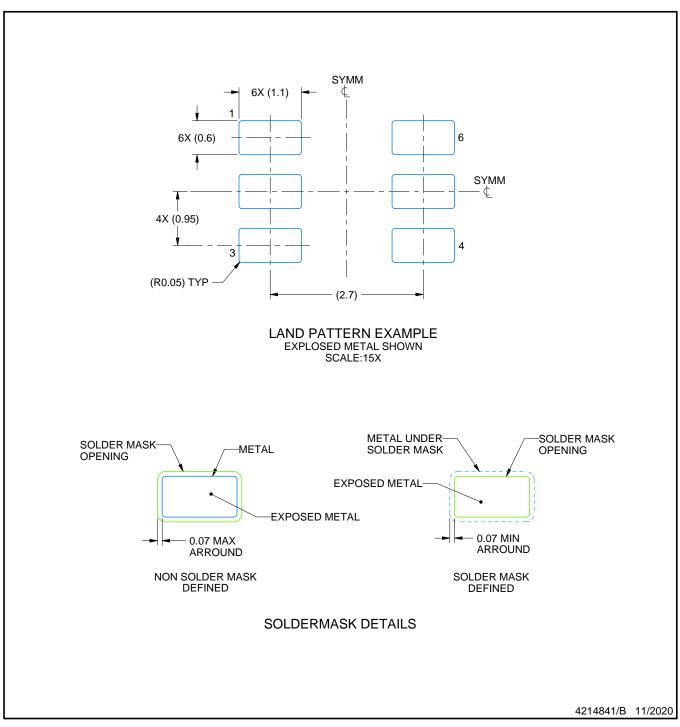


### NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
   This drawing is subject to change without notice.
   Reference JEDEC MO-193.



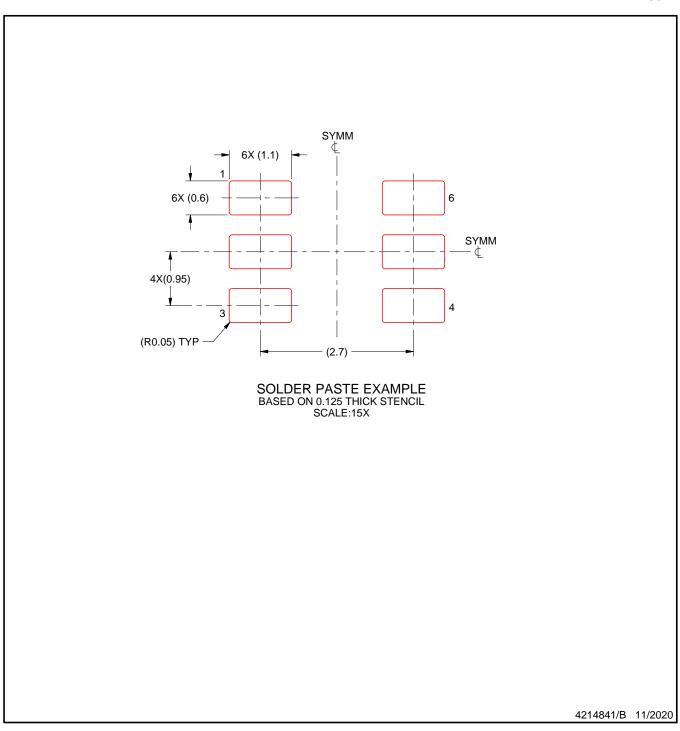
SOT



NOTES: (continued)

- 4. Publication IPC-7351 may have alternate designs.
- 5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

SOT



NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

  7. Board assembly site may have different recommendations for stencil design.



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